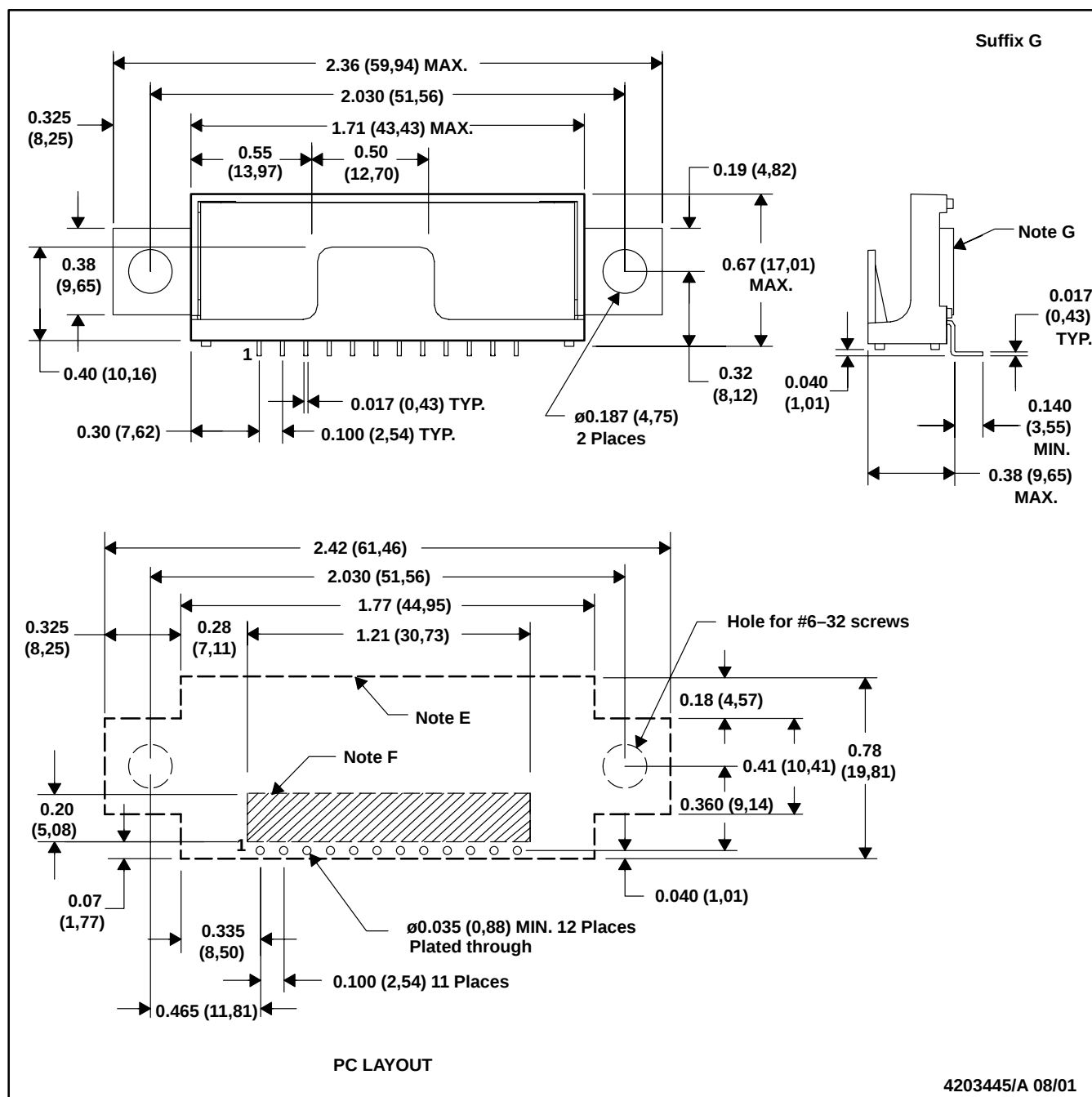


EBG (R-PSIP-T12)

PLASTIC SINGLE-IN-LINE MODULE



- NOTES:
- All linear dimensions are in inches (mm).
 - This drawing is subject to change without notice.
 - 2 place decimals are ± 0.030 (± 0.76 mm).
 - 3 place decimals are ± 0.010 (± 0.25 mm).
 - Recommended mechanical keep out area.

- No copper, power or signal traces in this area.
- The metal tab is isolated but electrically conductive. No signal traces are allowed under the metal tab area. A solid copper island is recommended, which may be grounded.

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Mailing Address:

Texas Instruments
Post Office Box 655303
Dallas, Texas 75265